

Bid Bulletin No. 2

Consulting Service for the Updating of the Semiconductor and Electronics Industry Roadmap, and the Conduct of Feasibility Study on Establishing a Wafer Fabrication Plant Bidding No. 24-010

May 24, 2024

This Bid Bulletin No. 2 is hereby issued to modify or amend the Bidding Documents.

Schedule of Proceedings

Activity	Schedule
Submission and Opening of Eligibility Documents	03 June 2024, 9:00 AM, for the Submission of Technical and Financial Documents, and 9:30 AM for the Opening of Technical Documents through video conference with the following details: Zoom Meeting: https://zoom.us/j/98359880044?pwd=RmZtK09LWGpyZTVp amdFSThoSFpqZz09 Meeting ID: 983 5988 0044
	Passcode: BAC2024
Pre-Bid Conference	10 June 2024, 9:30 AM, for the Pre-Bid Conference through video conference with the following details: Zoom Meeting: https://zoom.us/j/92525653231?pwd=Si8vb0hnR2VCd0pseFh6bXVwNVQ2UT09 Meeting ID: 925 2565 3231 Passcode: BAC2024
Submission of Technical and Financial Documents	24 June 2024, 9:00 AM, for the Submission of Technical and Financial Documents, and 9:30 AM for the Opening of Technical Documents through video conference with the following details: Zoom Meeting:
and	https://zoom.us/j/99165506813?pwd=aVR0dVhyalloRUpxYlhldTFibWcwdz09
Opening of Technical Documents	Meeting ID: 991 6550 6813 Passcode: BAC2024

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24 May 2024

Opening of Financial Documents	01 July 2024, 9:30 AM, for the Opening of Fina Documents through zoom video conference.	ıncial
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For the guidance and information of all concerned.

SGD.

KRISTIAN R. ABLAN

Assistant Secretary

Chairperson, DTI Bids and Awards Committee

C	Conforme:
_	Name and Signature of
	Authorized Representative
	Date: